AVAGO TECHNOLOGIES, INC. PDEnver, Solorado 80201-1920

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s):

Kong Weng Lee et al.

Serial No.:

10/608,605

Examiner: Owens, Douglas W

Filing Date: June 27, 2003

Group Art Unit: 2811

Telephone No. (404) 610-5689

Title: Packaging Device for Semiconductor Die, Semiconductor Device Incorporating Same

and Method of Making Same

**COMMISSIONER FOR PATENTS** P.O. Box 1450

Alexandria VA 22313-1450

TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT										
Sir	:									
Transmitted herewith is/are the following in the above-identified application:										
Response/Amendment Petition to ext							espond			
New fee as calculated below				Supplemental Declaration						
No additional fee (Address envelope to "Mail Stop Amendments")										
Other: (Fee \$)										
CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY										
F										
	(1) FOR	(2) CLAIMS REMAINING AFTER AMENDMENT	(3) NUMBER EXTRA	HIGHEST NUMBER PREVIOUSLY PAID FO	PRESENT	RATE	ADDIT	TIONAL ES	-	
	TOTAL CLAIMS	7	MINUS	20	= 0	X 50	\$	0		
	INDEP. CLAIMS	2	MINUS	3	= 0	X 200	\$	0		
	FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM + 360						\$	0		
	EXTENSION         1 <sup>ST</sup> MONTH         2 <sup>ND</sup> MONT           FEE         120.00         450.00					MONTH 0.00 🔲	\$ 0			
<b>—</b>				OTHER FEES \$ 0				0	1	
Ė	TOTAL ADDITIONAL FEE FOR THIS AMENDMENT \$							0	ł	
Charge \$ 0 to Deposit Account <b>50-3718</b> . At any time during the pendency of this application, please charge any fees required or credit any over payment to Deposit Account <b>50-3718</b> pursuant to 37 CFR 1.2 5. Additionally please charge any fees to Deposit Account <b>50-3718</b> under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate copy of this transmittal letter is enclosed.										
Respectfully submitted,										
					Kong Weng Lee et al.					
					By A. S.					
I hereby certify that this correspondence is being Deposited with the United States Postal Service as First class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450.					P. S. Dara C. Attorney/Agent for Applicant(s)					
Date of Deposit: 6/5/2006					Reg. No. 52,793					
Typed Name: P. S. Dara					Date: 6/5/2006					

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Confirmation No.: 2253
Kong Weng Lee

Group Art Unit: 2811

Serial No.: 10/608,605

Examiner: Owens, Douglas W

Filed: 6/27/2003

Docket No. 70030259-1

For: Packaging Device for Semiconductor Die, Semiconductor Device Incorporating

Same and Method of Making Same

## AMENDMENT AND RESPONSE

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

The outstanding final Office Action mailed April 6, 2006 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

## **AUTHORIZATION TO DEBIT ACCOUNT**

It is not believed that extensions of time or fees for net addition of claims are required, beyond those that may otherwise be provided for in documents accompanying this paper. However, in the event that additional extensions of time are necessary to allow consideration of this paper, such extensions are hereby petitioned under 37 C.F.R. § 1.136(a), and any fees required therefor (including fees for net addition of claims) are hereby authorized to be charged to Avago deposit account no. 50-3718.